ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES international and Pan-American co	burn, Illinois, All rights reserve	d under both leve	is documen el parts, the	t is a declaration e declaration enc	of the substance compasses all low	es within the manufacture ver level materials for wh	er listed ite	m. Note: if t nufacturer h	he item is an as as engineering	sembly with lower responsibility.	
2-21.1 IPC Web Site for Information on IPC-1752 Standard Form Type Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information								
Supplier Information											
ompany name* Company unique ID			Unique ID Authority				Response Date*				
onsemi								2025-06-05			
Contact Name	Title - Contact		Pl	Phone - Contact*			Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance		Ν	NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*	prized Representative* Title - Representative		Pł	Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product Enviro Compliance		NA		A		Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr Item	n Number Mfr Item Nam	e	E	Effective Date	Version	Manufacturing Site	W	'eight*	UOM	Unit Type	
NCV451	AMNWTBG 3A Ultra-Smal	lLoadSwitch	2	2025-06-05 MY1		MY1	11.33		mg	Each	
Manufacturing Proccess Information											
Terminal Plating / Grid Array Material T	al Terminal Base Alloy J-STD-020 M		ating	Peak Process Body Temperature Max Time at Pe		ture Max Time at Peak	k Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed	CU Alloy	1		260	С	30	second	s 3			
Comments											
evel 1 - maximum time at peak temperature during so	ldering is 10-30 seconds										
For more information regarding material composition	please refer to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			Ince category (JIG or Requester) or enter a va [F] Optionally enter the positive (+) and neg-				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.88	mg	Supplier	Silicon (Si)	7440-21-3		0.88	mg
Die Attach Tape	0.31	mg		Epoxy resin	proprietary data		0.0604	mg
			Supplier	Silver (Ag)	7440-22-4		0.2495	mg
Lead Frame 4.7	4.7	mg	Supplier	Tin (Sn)	7440-31-5		0.0117	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0103	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0117	mg
			Supplier	Copper (Cu)	7440-50-8		4.6662	mg
Lead Frame plating	0.03	mg	Supplier	Silver (Ag)	7440-22-4		0.03	mg
Mold Compound-Black 4	4.66	mg		Epoxy resin	proprietary data		0.233	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1072	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.233	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0186	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1072	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.961	mg
Plating	0.6	mg	Supplier	Tin (Sn)	7440-31-5		0.6	mg
Wire Bond - Au	0.15	mg	Supplier	Gold (Au)	7440-57-5		0.15	mg